# DUSEU

## Half-Bridge Gate Driver

### FAN7380-OP

#### Description

The FAN7380-OP is a monolithic half-bridge gate-drive IC for MOSFETs and IGBTs that operate up to +600 V. onsemi's high-voltage process and common-mode noise cancelling technique provide stable operation of high-side driver under high-dv/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to  $V_{S} = -9.8 \text{ V}$  (typical) for  $V_{BS} = 15 \text{ V}$ . The input logic level is compatible with standard TTL-series logic gates. The internal shoot-through protection circuit provides 100 ns dead-time to prevent output switching devices from both conducting during transition periods. UVLO circuits for both channels prevent malfunction when V<sub>CC</sub> and V<sub>BS</sub> are lower than the specified threshold voltage. Output drivers typically source / sink at 90 mA / 180 mA, respectively, which is suitable for fluorescent / compact fluorescent lamp ballast applications and systems requiring low di/dt noise.

#### Features

- Floating Channel Designed for Bootstrapping Operation to +600 V
- JATIVE FOR INFORM Typically 90 mA / 180 mA Sourcing/Sinking Current Driving Capability for Both Channels
- Common–Mode dv/dt Noise Cancelling Circuit
- Extended Allowable Negative V<sub>S</sub> Swing to -9.8 V for Signal Propagation at  $V_{CC} = V_{BS} = 15 \text{ V}$
- V<sub>CC</sub> & V<sub>BS</sub> Supply Range from 10 V to 20 V
- UVLO Functions for Both Channels
- TTL-Compatible Input Logic Threshold Levels
- Matched Propagation Delay Below 50 ns
- Built-in 100 ns Dead-Time Control Function
- Output In-Phase with Input Signal
- This is a Pb-Free Device

#### **Typical Applications**

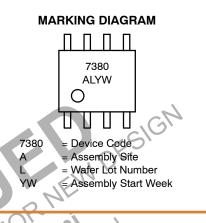
- SMPS
- Motor Driver
- PDP Scan Driver
- Industrial Application

#### **Related Resources**

- AN-6076 Design and Application Guide of Bootstrap Circuit for High-Voltage Gate-Drive IC
- <u>AN-9052</u> Design Guide for Selection of Bootstrap Components
- AN-8102 Recommendations to Avoid Short Pulse Width Issues in **HVIC Gate Driver Applications**



(8-SOP) CASE 751EG



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 11 of this

#### **TYPICAL APPLICATION CIRCUIT**

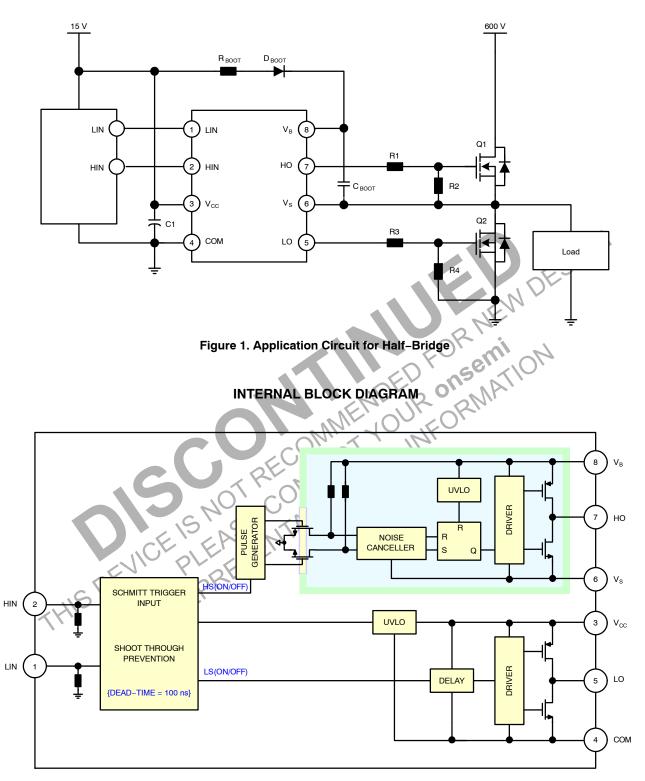


Figure 2. Functional Block Diagram

#### **PIN CONFIGURATION**

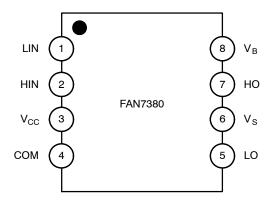


Figure 3. Pin Configuration (Top View)

#### **PIN DEFINITIONS**

Pin No.	Name	I/O	Description
1	LIN	I	Logic Input for Low-Side Gate Driver Output
2	HIN	I	Logic Input for High-Side Gate Driver Output
3	V <sub>CC</sub>	I	Low-Side Supply Voltage
4	COM		Logic Ground and Low-Side Driver Return
5	LO	0	Low-Side Driver Output
6	VS	I	High-Voltage Floating Supply Return
7	НО	0	High-Side Driver Output
8	VB		High-Side Floating Supply
	S DEVICE	PLEAS PLEAS REPRE	High-Side Driver Output High-Side Floating Supply

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Symbol	Parameter	Min	Max	Unit
VS	High-side Offset Voltage	V <sub>B</sub> – 25	V <sub>B</sub> + 0.3	V
VB	High-side Floating Supply Voltage	-0.3	625.0	
V <sub>HO</sub>	High-side Floating Output Voltage HO	V <sub>S</sub> – 0.3	V <sub>B</sub> + 0.3	
V <sub>CC</sub>	Low-side and Logic-fixed Supply Voltage	-0.3	25.0	
$V_{LO}$	Low-side Output Voltage LO	-0.3	V <sub>CC</sub> + 0.3	
V <sub>IN</sub>	Logic Input Voltage (HIN, LIN)	-0.3	V <sub>CC</sub> + 0.3	
COM	Logic Ground	V <sub>CC</sub> – 25	V <sub>CC</sub> + 0.3	
dV <sub>S</sub> /dt	Allowable Offset Voltage Slew Rate	-	50	V/ns
P <sub>D</sub> (Note 1, 2, 3)	Power Dissipation	-	0.625	W
$\theta_{JA}$	Thermal Resistance, Junction-to-ambient	-	200	°C/W
TJ	Junction Temperature	-	150	°C
Τ <sub>S</sub>	Storage Temperature	-50	150	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified.)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Mounted on 76.2 x 114.3 x 1.6 mm PCB (FR-4 glass epoxy material).

2. Heter to the following standards: JESD51-2: Integral circuits thermal test method environmental conditions – natural convection JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages
3. Do not exceed P<sub>D</sub> under any circumstances.
RECOMMENDED OPERATING RATINGS

Symbol	Parameter	Min	Max	Unit
VB	High-side Floating Supply Voltage	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
VS	High-side Floating Supply Offset Voltage	6 – V <sub>CC</sub>	600	
V <sub>HO</sub>	High-side (HO) Output Voltage	VS	VB	
$V_{LO}$	Low-side (LO) Output Voltage	СОМ	V <sub>CC</sub>	
V <sub>IN</sub>	Logic Input Voltage (HIN, LIN)	СОМ	V <sub>CC</sub>	
V <sub>CC</sub>	Low-side Supply Voltage	10	20	1
T <sub>A</sub>	Ambient Temperature	-40	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V <sub>CCUV</sub> + V <sub>BSUV</sub> +	V <sub>CC</sub> & V <sub>BS</sub> Supply Under-voltage Positive Going Threshold		8.2	9.2	10.0	V
V <sub>CCUV</sub> - V <sub>BSUV</sub> -	V <sub>CC</sub> & V <sub>BS</sub> Supply Under-voltage Negative Going Threshold		7.6	8.7	9.6	
V <sub>CCUVH</sub> V <sub>BSUVH</sub>	V <sub>CC</sub> Supply Under-voltage Lockout Hysteresis		-	0.5	-	
I <sub>LK</sub>	Offset Supply Leakage Current	V <sub>B</sub> = V <sub>S</sub> = 600 V	-	-	50	μA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>IN</sub> = 0 V or 5 V	-	44	100	
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current	V <sub>IN</sub> = 0 V or 5 V	-	70	180	
I <sub>PBS</sub>	Operating V <sub>BS</sub> Supply Current	f <sub>IN</sub> = 20 kHz, rms value	-	-	600	μA
I <sub>PCC</sub>	Operating V <sub>CC</sub> Supply Current	f <sub>IN</sub> = 20 kHz, rms value		-	610	
VIH	Logic "1" Input Voltage		2.5		310	V
V <sub>IL</sub>	Logic "0" Input Voltage		-	OK	0.8	
V <sub>OH</sub>	High-level Output Voltage, $V_{BIAS}$ - $V_O$	I <sub>O</sub> = 20 mA	-	<u> </u>	2.8	V
V <sub>OL</sub>	Low-level Output Voltage, V <sub>O</sub>		4r	-	1.2	
I <sub>IN+</sub>	Logic "1" Input Bias Current	V <sub>IN</sub> = 5 V		5	40	μA
I <sub>IN-</sub>	Logic "0" Input Bias Current	V <sub>IN</sub> = 0 V	.6-	1.0	2.0	
I <sub>O+</sub>	Output HIGH Short-circuit Pulse Current	V <sub>O</sub> = 0 V, V <sub>IN</sub> = 5 V with PW ≤[] 0 μs	60	90	-	mA
I <sub>O-</sub>	Output LOW Short-circuit Pulsed Current	V <sub>O</sub> = 15 V, V <sub>IN</sub> = 0 V with PW ≤[]0 μs	130	180	-	
$V_{S}$	Allowable Negative V <sub>S</sub> Pin Voltage for HIN Signal Propagation to HO	MNIL YOUNFO	-	-9.8	-7.0	V

**STATIC ELECTRICAL CHARACTERISTICS** ( $V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15.0 V,  $T_A$  = 25°C, unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to COM. The  $V_O$  and  $I_O$  parameters are referenced to  $V_S$  and COM and are applicable to the respective outputs HO and LO.)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

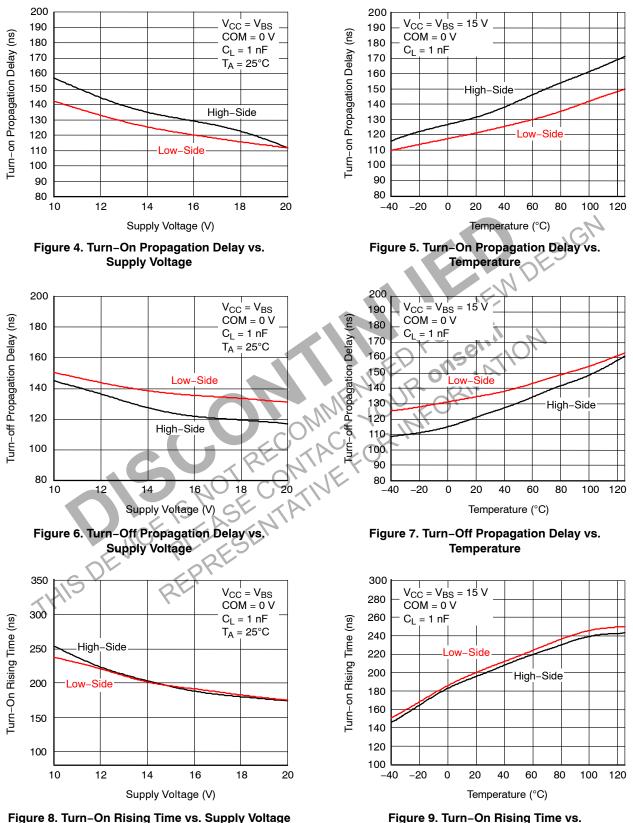
# **DYNAMIC ELECTRICAL CHARACTERISTICS** ( $V_{BIAS}$ ( $V_{CC}$ , $V_{BS}$ ) = 15.0 V, $V_S$ = COM, $C_L$ = 1000 pF and $T_A$ = 25°C, unless otherwise specified.)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
t <sub>on</sub>	Turn-on Propagation Delay	• V <sub>S</sub> = 0 V	70	135	200	ns
t <sub>off</sub>	Turn-off Propagation Delay	V <sub>S</sub> = 0 V or 600 V (Note 4)	60	130	190	
t <sub>r</sub>	Turn-on Rise Time		160	230	290	
t <sub>f</sub>	Turn-off Fall Time		20	90	160	
DT	Dead Time		80	120	190	
MT	Delay Matching, HS & LS Turn-on/off		-	_	50	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

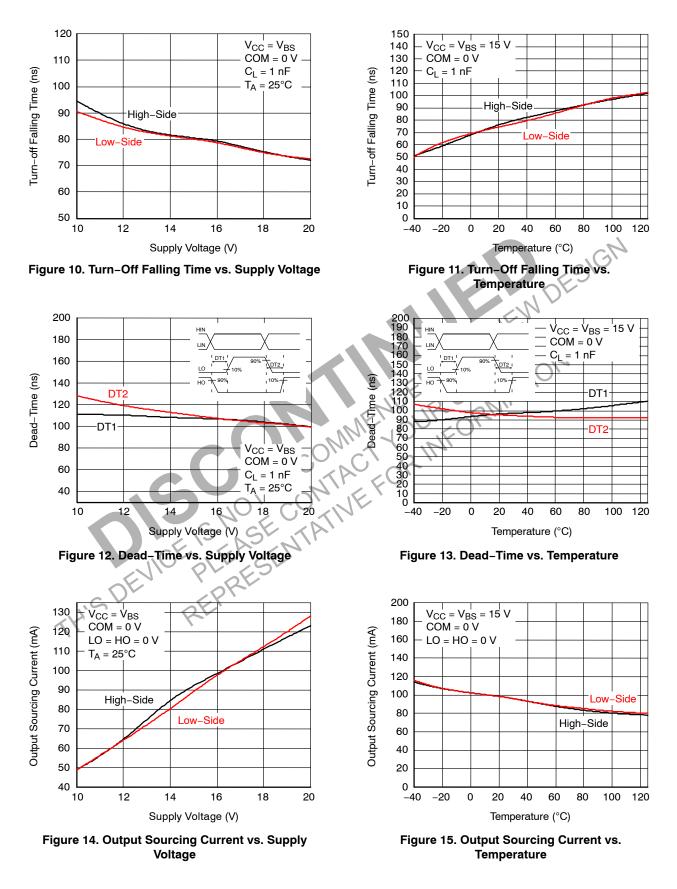
4. This parameter guaranteed by design.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

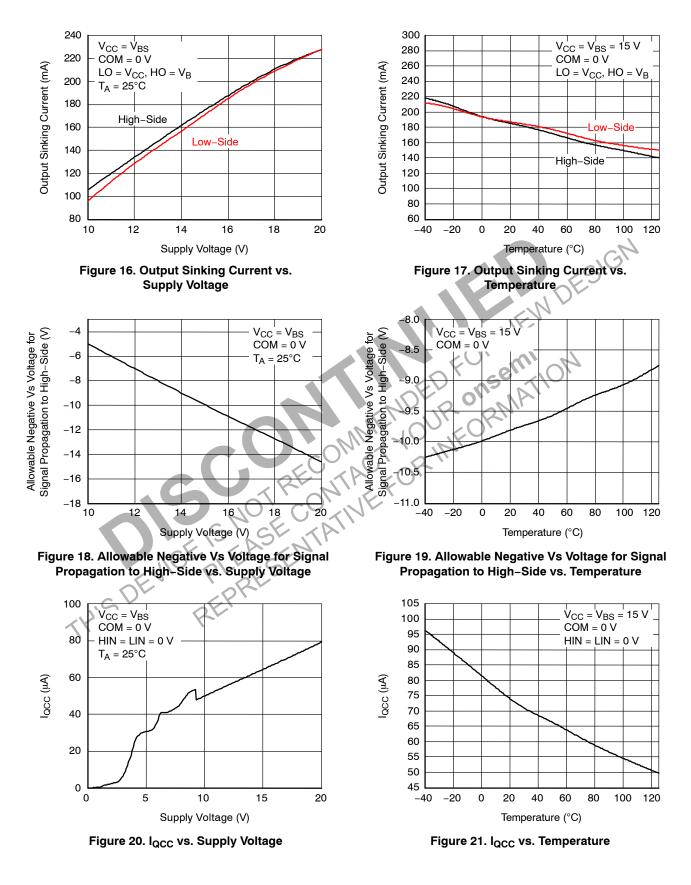


Temperature

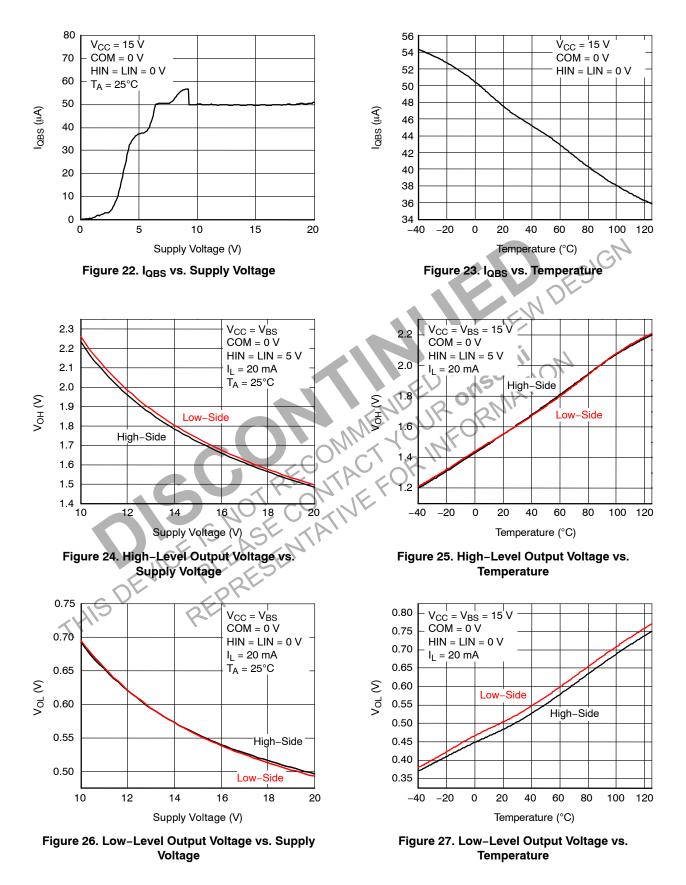
#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



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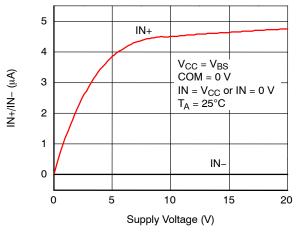
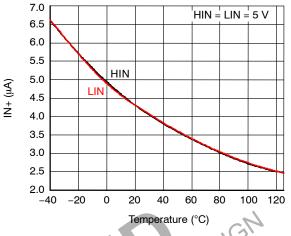
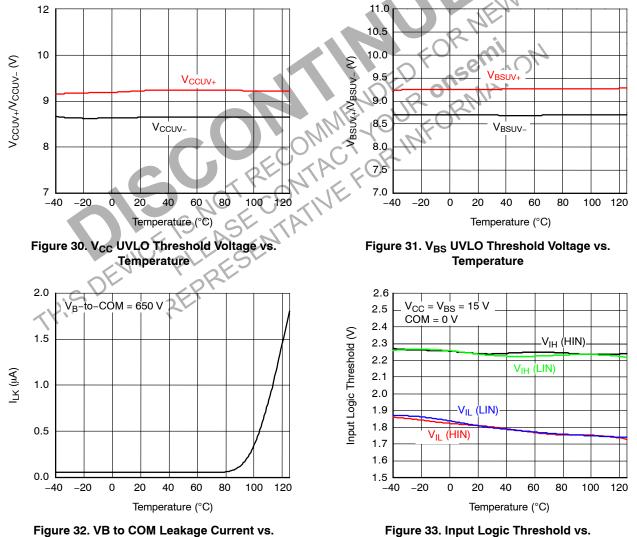


Figure 28. Input Bias Current vs. Supply Voltage





Temperature



Temperature

#### SWITCHING TIME DEFINITIONS

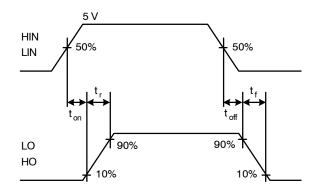


Figure 34. Switching Time Waveforms

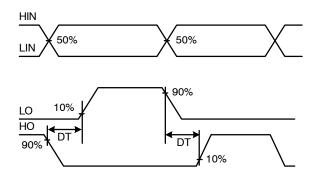
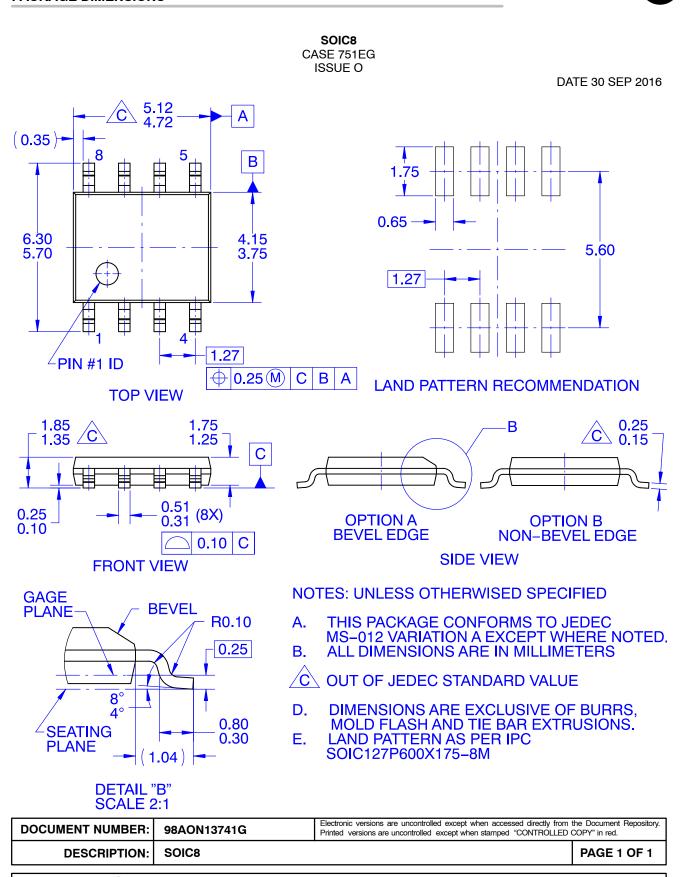


Figure 35. Internal Dead-Time Timing

#### **ORDERING INFORMATION**

Device	Package	Operating Temperature	Description	Shipping <sup>†</sup>
FAN7380MX-OP (Note 5)	SOIC8 (8–SOP) (Pb–Free)	-40°C~+125°C	General Application	3000 / Tape & Reel

5. This device has passed wave soldering test by JESD22A-111. TFor information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



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